

SPECIFICATION

宏致電子股份有限公司

桃園縣中壢市東園路13號

No.13, Dongyuan Rd., Jhongli City,

Taoyuan County 320, Taiwan (R.O.C.)

TEL: +886-3-463-2808 FAX: +886-3-463-1800

SPEC. NO.: PS-509	84-002XX-XXX	REVISION:			
PRODUCT NAME:	3.5mm Pitch SPEAKI	ER CONN. SMT TYPE			
PRODUCT NO:	50984-XXXXX-XXX	ζ.			
PREPARED:	CHECKED:	APPROVE	D:		

RYAN

2009/06/30

DATE:

JAMESLEN

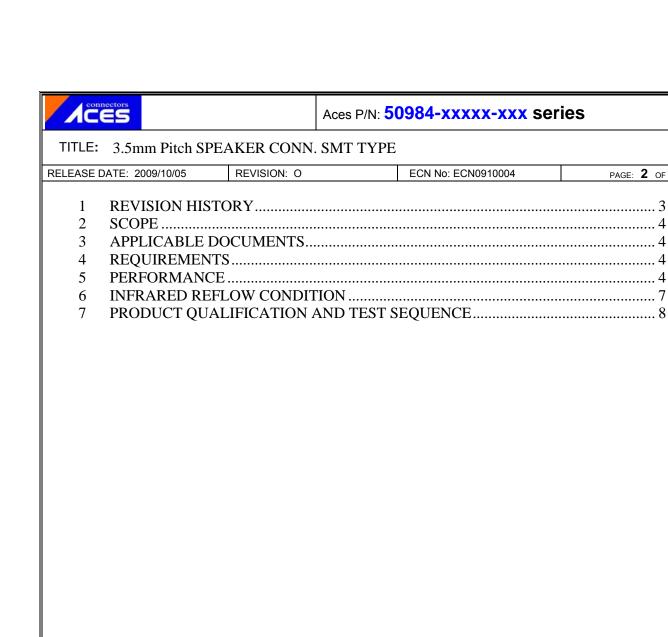
2009/06/30

DATE:

JASON

2009/06/30

DATE:



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A	Aces P/N: 50984-xxxxx-xxx series								
T	TITLE: 3.5mm Pitch SPEAKER CONN. SMT TYPE								
REL	RELEASE DATE: 2009/10/05								
1	Revisi	on History							
	Rev.	ECN#		Description		Approved	Date		
	O	ECN-0910004	RELEASED)		JASON	2009/10/05		



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2 SCOPE

This specification covers performance, tests and quality requirements for SPEAKER connector.

3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Gold plated based on order information

- (b) Under plate: Nickel-plated all over
- (c) Solder area: Gold plated based on order information
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.3 Ratings

4.3.1 Voltage: 60 Volts AC (per pin)

4.3.2 Current: 1.0 Amperes (per pin)

4.3.3 Operating Temperature : -40°C to +105°C

5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	1	Visual, dimensional and functional per applicable quality inspection plan.



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ELECTRICAL					
Item	Requirement	Standard			
Low-signal Level Contact Resistance	30 m Ω Max.(initial)per contact 40 m Ω Max.(Final)per contact \triangle R 10 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 1mA Max. (EIA-364-23)			
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)			
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current after:1 A/Power contact. The temperature rise above ambient shall not exceed 30°C The ambient condition is still air at 25°C (EIA-364-70 METHOD 2)			
Dielectric Withstanding Voltage	300 VAC Min. at sea level for 1 minute. No discharge, flashover or breakdown. Current leakage: 1 mA max.	Test between adjacent contacts of unmated connectors. (EIA-364-20)			
	MECHANICAL	-			
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)			
Normal Forces	0.7N MIN.	Mate connector with a suitable gauge for each pin at rate of 25 .4mm/min. Measure force when the height 1.0mm form mount side. (EIA-364-04)			
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 200 Hz. The entire frequency range, from 10 to 200 Hz and return to 10 Hz, shall be traversed in approximately 20 minute. Acceleration: each direction 2.5G This motion shall be applied for 3 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)			



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MECHANICAL							
Item	Requirement	Standard					
Terminal / Housing Retention Force	0.15kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute On the terminal assembled in the housing.					
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)					
	ENVIRONMENTA	L					
Item	Requirement	Standard					
Resistance to Hand	See Product Qualification and Test	Soldering iron : 350°C±10°C					
Soldering Heat	Sequence Group 9	Duration:3~4sec Max.					
Resistance to Reflow	No deformation of components	Pre Heat : 150°C~180°C, 60~120sec					
Soldering Heat	Affecting performance.	Heat : 230°C Min., 40sec Min.					
3		Peak Temp. : 260°C Max,					
		10sec Max.					
		Mate module and subject to follow					
		condition for 5 cycles.					
	See Product Qualification and Test						
Thermal Shock	Sequence Group 3	-40 +0/-3 ℃, 30 minutes					
	Coquerios Group C	+105 +3/-0 °C, 30 minutes					
		(EIA-364-32, test condition A)					
		Mated Connector to follow					
		condition for 7 cycles					
High Humidity Storage	See Product Qualification and Test	1 cycles:					
ing. Hamaily olologo	Sequence Group 3	40°C, 95%RH, 24H					
		(EIA-364-31, Test condition A)					
		Mated Connector					
	See Product Qualification and Test						
High Humidity Operation	Sequence Group 3	Reefer to Method II.					
		(EIA-364-31, Test condition A)					
	1	Subject mated connectors to					
	See Product Qualification and Test						
Cold Resistance	Sequence Group 4	hours. Measure Signal.					
		(EIA-364-17, Test condition A)					
		Subject mated connectors to					
	See Product Qualification and Test						
Hot Resistance	Sequence Group 10	hours. Measure Signal.					
	1224monios Sisab is	(EIA-364-17, Test condition A)					



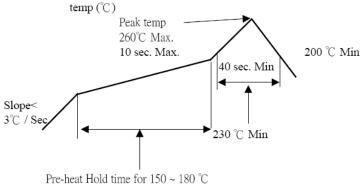
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Damp heat cycling	See Product Qualification and Test Sequence Group 8	Subject specimens to continuous 20cycles.(60H) 1 cycle: -20°C 0%,1H→30min(ramp time) →40°C 40%,1H Temp(°C) 40°C -20°C 1 Cycle) Time(Min) 30 Min (1 Cycle)
Salt Spray	See Product Qualification and Test Sequence Group 5	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C for 8 hours. (EIA-364-26,Test condition B)
Solder ability	Solder able area shall have minimum of 95% solder coverage See Product Qualification and Test Sequence Group 6	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)

6 INFRARED REFLOW CONDITION

Lead-free Process

$\frac{\text{TEMPERATURE CONDITION GRAPH}}{\text{(TEMPERATURE ON BOARD PATTERN SIDE)}}$



is 60 ~ 120 sec.



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product	1 . 7	1 ` 6	1 . 7	1 \ 4	1 \ 3			1 . 3	1 . 3	1 \ 4	1 . 3
Low-signal Level Contact Resistance	2 ` 6	2 ` 5	2 \ 10	2 ` 5						2 ` 5	
Insulation Resistance			3、9								
Dielectric Withstanding Voltage			4 \ 8								
Normal Forces	3 \ 5										
Durability	4										
Terminal / Housing Retention Force							1				
Vibration		3									
Shock (Mechanical)		4									
Thermal Shock			5								
High Humidity Storage / High Humidity Operation			6								
Cold Resistance				3							
Salt Spray					2						
Solder ability						1					
Resistance to Soldering Heat									2		
Damp heat cycling								2			
Hot Resistance										3	
Temperature rise											2
Sample Size	4	4	8	4	4	2	4	4	4	4	2